FA-A-0417-A

Change of External Appearance of Terminating Resistor for the MELSEC Series CC-Link System (Manufactured in September 2023 and after)

■Date of Issue
September 2023
■Relevant Models
RJ61BT11, QJ61BT11N, LJ61BT11, L26CPU-BT, L26CPU-PBT, NZ2GF-CCB

Thank you for your continued support of Mitsubishi Electric programmable controllers.

This technical bulletin informs you that the external appearance of the terminating resistor included with the CC-Link module will be changed.

There is no impact on the general specifications, performance specifications, functions, and external dimensions of products due to the change.
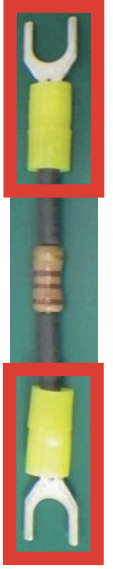
1   RELEVANT MODELS

The following table lists the relevant models.

Series	Product	Model
MELSEC iQ-R	CC-Link system master/local module	RJ61BT11
MELSEC-Q	CC-Link system master/local module	QJ61BT11N
MELSEC-L	CC-Link system master/local module	LJ61BT11
	CPU module	L26CPU-BT
		L26CPU-PBT
—	CC-Link IE Field Network - CC-Link bridge module	NZ2GF-CCB

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2   DETAILS ON THE CHANGES

The following shows change details.

Change details	Before change	After change
The solderless terminal part will be 3mm shorter. There is no impact on the performance and functions due to the change.		

3   REASON FOR THE CHANGE

To ensure stable procurement of parts and productivity.

4   SCHEDULE

The change will be applied to the products manufactured on and after September 2023.

Note that, depending on stock status, both the old and new products may be distributed in the market around that time.

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REVISIONS

Version	Date of Issue	Revision
A	September 2023	First edition

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